



IEEE Standard Format for LSI-Package-Board Interoperable Design

IEEE Computer Society

Developed by the
Design Automation Standards Committee

IEEE Std 2401™-2019
(Revision of IEEE Std 2401™-2015)

STANDARDS

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IEEE Standard Format for LSI-Package- Board Interoperable Design

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Design Automation Standards Committee
of the
IEEE Computer Society

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IEEE SA Standards Board

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Abstract: A method is provided for specifying a common interoperable format for electronic systems design. The format provides a common way to specify information/data about the project management, netlists, components, design rules, and geometries used in the large-scale integration-package-board designs. The method provides the ability to make electronic systems a key consideration early in the design process; design tools can use it to seamlessly exchange information/data.

Keywords: common interoperable format, components, design analysis, design rules, geometries, IEEE 2401™, large-scale integration (LSI), netlists, packages for LSI circuits, printed circuit board, project management, Verilog-HDL

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Introduction

This introduction is not part of IEEE Std 2401-2019, IEEE Standard Format for LSI-Package-Board Interoperable Design.

To deal with the increasing difficulty of design and the cost competitiveness of the global market, and to shorten the development term, innovative design methodologies should be implemented. It has been difficult to achieve the optimization of an entire set of large-scale integration (LSI), package, and board (LPB) using individual design processes for each LPB part.

One possibility for optimization is to have a certain section design the whole LPB; however, gathering knowledge and integrating the design environment of each LPB part is difficult. Dedicated professional technicians of individual LPB parts, who have the best knowledge and performance of their own part's design tools, intend to create design optimization by having proper interoperable information exchanges among all LPB parties. In order to achieve a design that optimizes the balance between cost and performance, information about and the results of design should be well shared among cooperating LPB design sections.

The standard format of LSI package board interoperable design (hereinafter called *LPB Format*) was developed to make it easier to exchange information among LPB design departments, so that optimal design will be carried out quickly.

The LPB interoperable design process has the following issues:

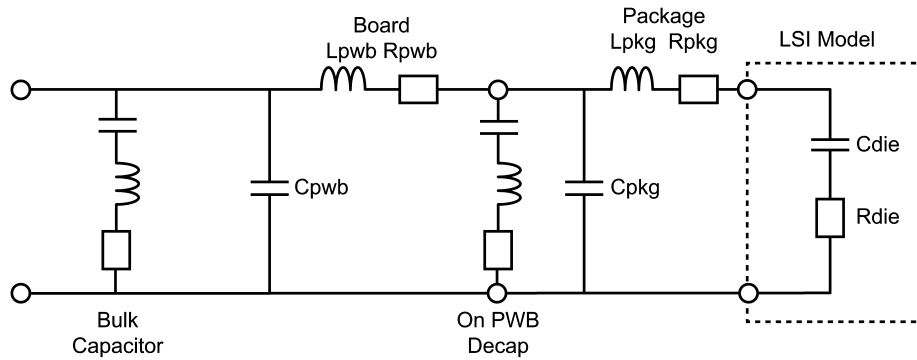
- Netlist not unified on each LPB
- Complexity of the representation of the relationship as a whole arrangement of the LPB
- Differences in how to give the design constraints, lack of design information, and many discrepancies in design rules
- Databases not unified in each LPB, or among different vendors
- No unified terms

Various problems caused by these issues include the following:

- A large effort is required for conversion of formats.
- The occurrence of conversion errors and connection errors is difficult to detect because there is a lack of the information needed to do so.
- It takes a long time to gather information, resulting in a long period of design and analysis.
- It is difficult to make optimal design changes because the entire verification process is difficult.
- Electronic design automation (EDA) tool cost increase because of additional development required to support multiple formats.
- It is time consuming for designers to communicate their intentions in a way that others understand.

Based on this analysis, the interface LPB Format has been developed which can address these issues.

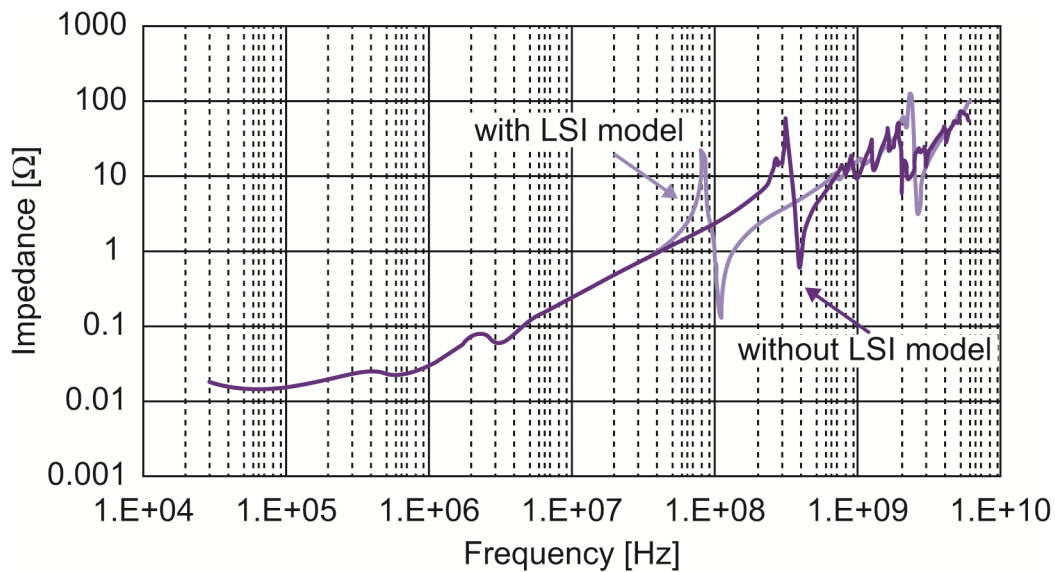
As the one of the case studies of the LPB interoperable design process, the power distribution network (PDN) should be designed with information about the other LPB parts to reduce the noise (see Figure i).



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Figure i—Power distribution network

Resonance is caused by a capacitance and inductance present in the various parts in the LPB PDN. Impedance at the resonant frequency will be extremely large. If each part of the overall LPB design is not accurately simulated in the PDN model, the power supply circuit cannot be correctly designed (see Figure ii).



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Figure ii—Example of PDN impedance

In order to run properly, this simulation should align a variety of information, such as the circuit model of power distribution network (PDN) of LSI, shape information about the package and board, electrical parameters of materials, and models of the components. It is difficult to make an efficient design when the specification or format of the design information is different in each part of the LPB, and the necessary parameters are not shared. When the format of the interface methods and models of the simulation are not consistent, the setup time and the cost of design/verification are enormous, which has become a barrier to cooperation in LPB design. The LPB Format will be evolved to create a mutual interface to enable a more efficient co-design environment.

Contents

1. Overview	11
1.1 Scope	11
1.2 Purpose	11
1.3 Key characteristics of the LSI-Package-Board Format.....	11
1.4 Contents of this standard	12
1.5 Word usage.....	13
2. Normative references.....	13
3. Definitions, acronyms, and abbreviations	13
3.1 Definitions	13
3.2 Acronyms and abbreviations	16
4. Concept of the LPB Format.....	18
4.1 Technical background.....	18
4.2 Conventional design	18
4.3 Common problems at the design site.....	19
4.4 Concept of LPB interoperable design.....	19
4.5 Value creation by LPB interoperable design	19
4.6 LPB Format	21
4.7 Summary of LPB Format files.....	21
5. Language basics.....	27
5.1 General	27
5.2 Typographic and syntax conventions	27
5.3 Character information.....	28
5.4 Notation of the floating point number	28
5.5 File naming definitions.....	28
6. Common elements in M-Format, C-Format, and R-Format	29
6.1 General	29
6.2 The <extensions> element	29
6.3 The <header> element	30
6.4 The <global> element.....	32
7. M-Format.....	48
7.1 M-Format file structure.....	48
7.2 The <include> element	49
7.3 The <current_phase> element.....	49
7.4 The <class> element.....	50
8. C-Format	56
8.1 C-Format file structure	56
8.2 The <module> element.....	56
8.3 The <component> element	161
9. R-Format	165
9.1 R-Format file structure	165
9.2 The <Physicaldesign> element.....	166
9.3 The <Constraintrule> element.....	201

10. N-Format	211
10.1 Purpose of the N-Format file	211
10.2 How to identify the power/ground network	211
10.3 Example	212
11. G-Format	212
11.1 Language basics of G-Format	212
11.2 Structure	213
11.3 Header section	214
11.4 Material section	215
11.5 Layer section	215
11.6 Shape section	216
11.7 Board geometry section	220
11.8 Padstack section	221
11.9 Part section	222
11.10 Component section	224
11.11 Net attribute section	225
11.12 Netlist section	225
11.13 Via section	227
11.14 Bondwire section	228
11.15 Route section	229
Annex A (informative) Bibliography	233
Annex B (informative) Examples of utilization	235
B.1 Understanding the function of the LPB Format	235
B.2 Test bench	235
B.3 Design flow example	237
B.4 Growth of the sample files in the LPB Format	269
B.5 Simulations using the sample files in the LPB Format	273
Annex C (informative) XML Encryption	275
Annex D (informative) MD5 checksum	278
Annex E (informative) Chip-Package Interface Protocol	279
E.1 General	279
E.2 Comparison of C-Format with Chip-Package Interface Protocol	279
Annex F (informative) M-Format usage examples	284
F.1 General	284
F.2 Bundling files for a product	284
F.3 Bundling files for a library	285
F.4 Managing design versions using M-Format	287
Annex G (informative) Example of how to express the connector parts as terminals	288
G.1 General	288

IEEE Standard Format for LSI-Package-Board Interoperable Design

1. Overview

1.1 Scope

This standard defines a common interoperable format that will be used for the design of a) large-scale integration (LSI), b) packages for such LSI, and c) printed circuit boards on which the packaged LSIs are interconnected. Collectively, such designs are referred to as *LSI-Package-Board (LPB)* designs. The format provides a common way to specify information/data about the project management, netlists, components, design rules, and geometries used in LPB designs.

1.2 Purpose

The general purpose of this standard is to develop a common format that LPB design tools can use to exchange information/data seamlessly, as opposed to having to work with multiple different input and output formats.

1.3 Key characteristics of the LSI-Package-Board Format

The LPB Format will facilitate the exchange of design information. This functionality provides the ability to plan the entire design at an early stage. In effect, post-design analysis will be possible throughout the entire LPB design process. Analysis of each part of the design can be examined in relation to all other parts of the design to determine the optimal point to give feedback for appropriate design changes throughout the LPB. This will promote the overall optimization of the design process.

The LPB Format is constructed out of the following five formats (see Figure 1):

- a) Project Management (M-Format)
- b) Netlist (N-Format)
- c) Component (C-Format)
- d) Design Rule (R-Format)
- e) Geometry (G-Format)